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Registered Hex PECL to TTL Translator

Description

The MC10H/100H607 is a 6-bit, registered PECL to TTL translator. The device features differential PECL inputs for both data and clock. The TTL outputs feature 48 mA sink, 24 mA source drive capability for driving high fanout loads or transmission lines. The asynchronous master reset control is an ECL level input.

With its differential PECL inputs and TTL outputs the H607 device is ideally suited for the receive function of a HPPI bus type board-to-board interface application. The on chip registers simplify the task of synchronizing the data between the two boards.

The device is available in either ECL standard: the 10H device is compatible with MECL $10H^{\intercal M}$ logic levels, with a V_{CC} of +5.0 V, while the 100H device is compatible with 100K logic levels, with a V_{CC} of +5.0 V.

Features

- Differential ECL Data and Clock Inputs
- 48 mA Sink, 24 mA Source TTL Outputs
- Single Power Supply
- Multiple Power and Ground Pins to Minimize Noise
- Pb-Free Packages are Available*



ON Semiconductor®

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PLCC-28 FN SUFFIX CASE 776

MARKING DIAGRAM*



xxx = 10 or 100

A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

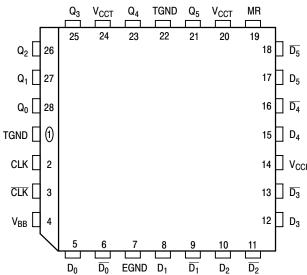


Figure 1. Pinout: PLCC-28 (Top View)

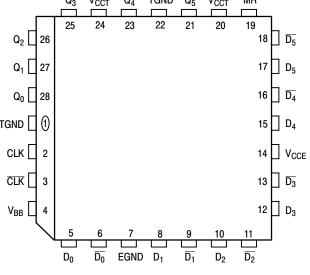


Table 1. PIN NAMES

Pin	Function
$\begin{array}{c} D_0 - D_5 \\ \overline{D_0} - \overline{D_5} \\ CLK, \overline{CLK} \\ MR \\ Q_0 - Q_5 \end{array}$	True PECL Data Inputs Inverted PECL Data Inputs Differential PECL Clock Input PECL Master Reset Input TTL Outputs
V _{CCE} V _{CCT} TGND EGND	PECL V _{CC} TTL V _{CC} TTL Ground PECL Ground

Table 2. TRUTH TABLE

D _n	MR	TCLK/CLK	Q _n + 1
L H X Open Input	LHX	Z Z X X	JIJJ

Z = LOW to HIGH Transition

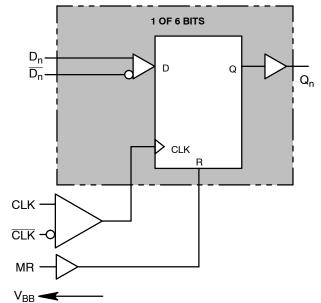


Figure 2. Logic Diagram

Table 3. 10H PECL DC CHARACTERISTICS (V_{CCT} = V_{CCE} = 5.0 V ± [5%)

			T _A = 0°C		T _A =	T _A = 25°C		T _A = 85°C	
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
I _{INH}	Input HIGH Current			255		175		175	μΑ
I _{INL}	Input LOW Current			0.5		0.5		0.5	μΑ
V _{IH}	Input HIGH Voltage	V _{CCT} = 5.0 V	3830	4160	3870	4190	3930	4280	mV
V _{IL}	Input LOW Voltage	V _{CCT} = 5.0 V	3050	3520	3050	3520	3050	3555	mV
V_{BB}	Output Bias Voltage	V _{CCT} = 5.0 V	3600	3710	3630	3730	3670	3790	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. PECL V_{IL}, V_{IH}, V_{OL}, V_{OH}, V_{BB} are given for V_{CCT} = V_{CCE} = 5.0 V and will vary 1:1 with power supply.

Table 4. 100H PECL DC CHARACTERISTICS (V_{CCT} = V_{CCE} = 5.0 V ±[5%)

			T _A = 0°C		°C T _A = 2!		$T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$		
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
I _{IH}	Input HIGH Current			255		175		175	μΑ
I _{IL}	Input LOW Current			0.5		0.5		0.5	μΑ
V _{IH}	Input HIGH Voltage	V _{CCT} = 5.0 V	3835	4120	3835	4120	3835	4120	mV
V _{IL}	Input LOW Voltage	V _{CCT} = 5.0 V	3190	3525	3190	3525	3190	3525	mV
V _{BB}	Output Bias Voltage	V _{CCT} = 5.0 V	3600	3720	3600	3720	3600	3720	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. PECL V_{IL} , V_{IH} , V_{OL} , V_{OH} , V_{BB} are given for $V_{CCT} = V_{CCE} = 5.0 \text{ V}$ and will vary 1:1 with power supply.

Table 5. 10H/100H TTL DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0 \text{ V} \pm 5\%$)

			T _A = 0°C		$T_A = 0^{\circ}C$ $T_A = 2$		$T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$		
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = -15 mA I _{OH} = -24 mA	2.5 2.0		2.5 2.0		2.5 2.0		V
V _{OL}	Output LOW Voltage	I _{OL} = 48 mA		0.55		0.55		0.55	V

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. DC levels such as V_{OH} , V_{OL} , etc., are standard for PECL and FAST devices, with the exceptions of: I_{OL} = 48 mA at 0.5 V_{OL} ; and I_{OH} = -24 mA at 2.0 V_{OH} .

Table 6. DC CHARACTERISTICS (V_{CCT} = V_{CCE} = 5.0V ±[5%)

		T _A = 0°C		T _A = + 25°C			T _A = + 85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	ECL Power Supply Current 10H 100H		70 65	85 80		70 70	85 85		70 75	85 95	mA
I _{CCL}	TTL Supply Current		100	120		100	120		100	120	mA
I _{CCH}	TTL Supply Current		100	120		100	120		100	120	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 7. AC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0 \text{ V} \pm [5\%]$

			$T_A = 0^{\circ}C$		0°C T _A = + 25°C		T _A = + 85°C		
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
t _{PLH} t _{PHH}	Propagation Delay to Output CLK to Q	CL = 50 pF	5.5 4.6	7.7 7.7	6.0 4.9	8.2 8.3	6.7 5.9	10.0 10.0	ns
t _{PHL}	Propagation Delay to Output MR to Q	CL = 50 pF	4.4	7.5	4.7	8.1	5.8	10.5	ns
t _{PW}	Minimum Pulse Width CLK, MR		1.0		1.0		1.0		ns
t _r	Rise Time	1.0 V to 2.0 V	0.5	2.0	0.5	2.0	0.5	2.0	ns
t _f	Fall Time	1.0 V to 2.0 V	0.5	2.0	0.5	2.0	0.5	2.0	ns
t _S	Setup Time		1.5		1.5		1.5		ns
t _H	Hold Time		1.5		1.5		1.5		ns
V_{PP}	Minimum Input Swing		200		200		200		mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10H607FN	PLCC-28	37 Units / Rail
MC10H607FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC100H607FN	PLCC-28	37 Units / Rail
MC100H607FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC100H607FNR2	PLCC-28	500 / Tape & Reel
MC100H607FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{4.} Numbers are for both ++ and -- delay MR to Q.

Resource Reference of Application Notes

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

AND8020/D - Termination of ECL Logic Devices

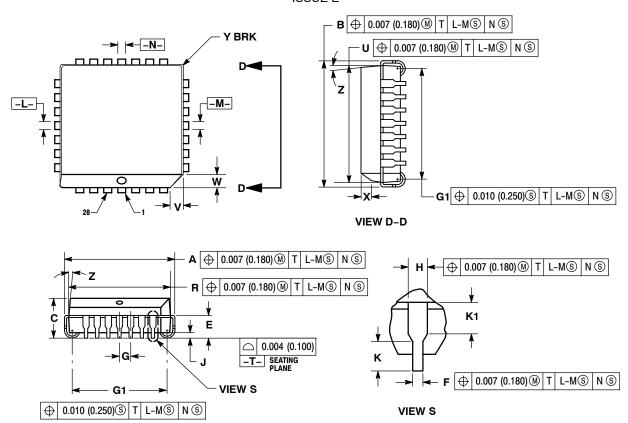
AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

PLCC-28 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 776-02 ISSUE E



- DATUMS -L-, -M-, AND -N- DETERMINED
 WHERE TOP OF LEAD SHOULDER EXITS
- PLASTIC BODY AT MOLD PARTING LINE.

 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

- 0.010 (0.250) PER SIDE.
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 5. CONTROLLING DIMENSION: INCH.
 6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BUIRDS, GATE BUIRDS, AND INTERLIFAD. BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- 7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.485	0.495	12.32	12.57
В	0.485	0.495	12.32	12.57
С	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2 °	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040		1.02	

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